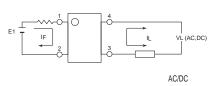
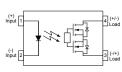
SUPSIC®

Parameter	Symbol	Rating	Units	
Load Voltage	VL	40	V	
Load Current	lι	2	Α	
On-Resistance	Ron	0.06	Ω	
I/O Breakdown Voltage	V/IO	5000	Vrms	





- 1. LED Anode
- 2. LED Cathode
- 3.4. Drain(MOS FET)



SUPSiC PhotoRelays

- Long life (No limit on mechanical and electrical
- lifetime)Bounce-free switching
- · Higher speed and high frequency switching
- Higher sensitivity (less power consumption)
- Immunity to EMI or RFI

- No have voltaic arc, bounce, and noise More
- resistant to vibration and impact AC or DC load
- switching
- Small package size

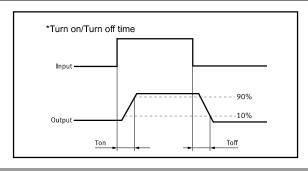
Applications

- Telecom/Datacom switching
- Multiplexers
- Meter reading systems
- Data acquisition
- Medical equipment
- Battery monitoring
- I/O Sub-Systems

- Robotics
- Aerospace
- Home/Safety security systems
- Process Control
- Energy Management
- Reed Relay EMR Replacement
- Programmable Controllers

TPYES

Category Output Rating Load Voltage Load Current		Doolsons	Part No.	Packing Quantity	
		Package	Fait No.		
AC/DC 40V 2A	24	DIP-4	GAQY211G2E	100pcs /tube	
	40 V	ZA	SMD-4	GAQY211G2EH	2000pcs /reel





Absolute Maximum Ratings (Ta = 25°C)

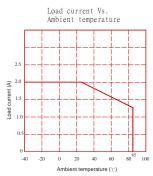
	Item	Symbol	Va l ue	Units	Note
	Continuous LED Current	lF	50	mA	
Input	Peak LED Current	Ігр	1000	mA	f=100Hz, duty=1%
	LED Reverse Voltage	VR	5	V	
	Input Power Dissipation	P _{In}	75	mW	
	Load Voltage	V∟	40	V(AC peak or DC)	
	Load Current	l.	2.0	Α	
Output	Peak Load Current	Peak	2.5	Α	100ms(1 pulse)
	Output Power Dissipation	Pout	1.8	W	
Total Power	Dissipation	Р⊤	2	W	
I/O Breakdov	vn Vo l tage	V _{I/O}	5000	Vrms	RH=60%, 1min
Operating Te	emperature	Торг	-40 to 85	℃	
Storage Tem	perature	T _{stg}	-40 to 100	℃	
Pin Soldering	g Temperature	T _{sol}	260	°C	10 sec max.

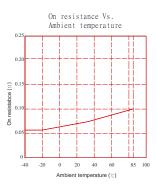
Electrical Characteristics (Ta = 25°C)

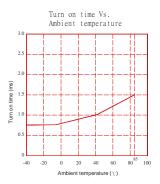
	Item	Symbol	MIN.	TYP.	MAX.	Units	Conditions
	LED Forward Voltage	VF		1.2	1.4	٧	I⊧=10mA
	Operation LED Current	Fon		0.5	3.0	mA	
Input	Recovery LED Current	Foff		0.35	0.5	mA	
	Recovery LED Voltage	V_{Foff}	0.5			٧	
							I⊧=5mA,I∟=Max
Output	On-Resistance	Ron		0.06	0.1	Ω	Time to flow is within 1 sec.
	Off-State Leakage	Leak		0.1		uA	V _∟ =Rating
	Current	Loak					VI Hading
	Output Capacitance	C_{out}		185		pF	V∟=0, f=1MHz
Transmis	Turn-On Time	Ton		0.8	1.5	ms	I⊧=5mA, I∟=Max
sion	Turn-Off Time	T_{off}		0.02	0.5	ms	
0	I/O Isolation Resistance	Rı⁄o	10 ¹⁰			Ω	DC500V
Coupled	I/O Capacitance	Сі/о		0.8	1.5	pF	f=1MHz

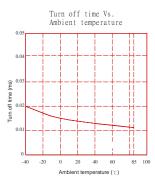
Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value): IF ≥5mA and ≤30mA

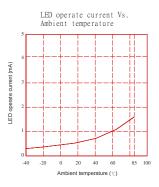
Engineering Data

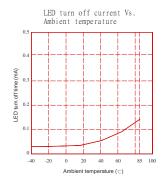


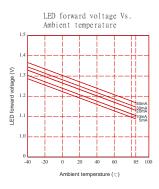


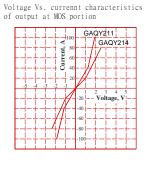


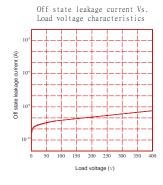


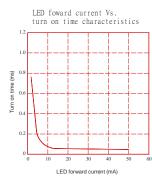


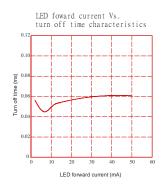


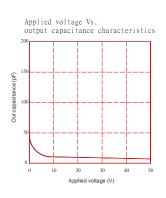






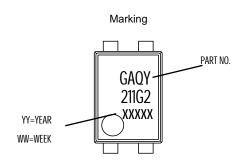


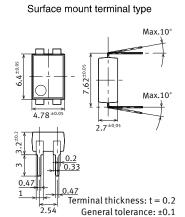


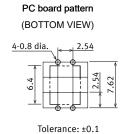


Dimensions and DIP-4 Package

Unit: mm







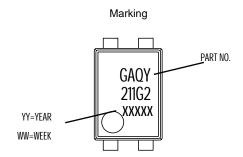
DIP Tape dimensions

Unit: mm inch

Devices are packaged in a tube so that pin No. 1 is on the stopper B side. Observe correct orientation when mounting them on PC boards.



Dimensions and SMD-4 Package Unit: mm

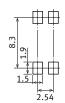


Surface mount terminal type Max.10° Supplementary of the supplementary

Terminal thickness: t = 0.2 General tolerance: ±0.1

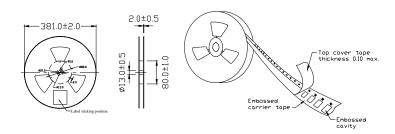
Recommended mounting pad

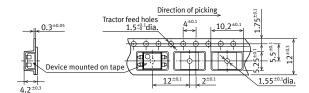
(TOP VIEW)



Tolerance: ±0.1

Tape dimensions (tape reel)

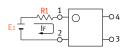


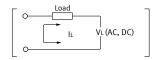




Using Methods

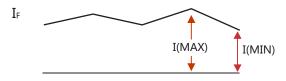
Examples of resistance value to control LED forward current (IF=5mA)





E1	R1 (Approx)
3.3V	300 Ω
5.0V	600 Ω
12V	1.9KΩ
24V	4.1K Ω

LED forward current must be more than 5mA , at I(MIN) ,and less than 30mA , at I(MAX).



Recommended Operating Conditions

Please obey the following conditions to ensure proper device operation and resetting. Input LED current (Recommended value):

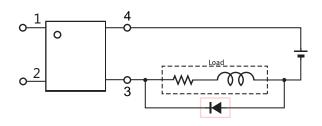
Characteristic	Symbol	Min	Тур.	Max	Unit
Forward current	lF	5.0	7.0	30	mA

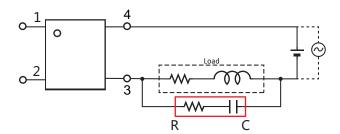
Protection Circuit

Output spike voltages:if an inductive load generates spike voltages which exceed heabsolute maximum rating, the spike voltage shall be limited.

Clamp diode is connected in parallel with the load. Absorb capacity with external diode.

CR Snubber is connected in parallel with the load. Absorb capacity with buffer capacity.





When adding diodes, buffer circuits (C-R), and other protections, they need to be installed near the MOS RELAY to be effective. Adding protection elements may result in a slow reset time, so adjust them according to the actual situation before use.

Note: When developing designs using this product, perform the expected performance of the equipment under the operating conditions recommended by the guidelines in this document. Continuous use under heavy loads (including, but not limited to, the application of high temperatures/current/voltage and significant changes in temperature, etc.) may result in deterioration of the reliability of this product.

单击下面可查看定价,库存,交付和生命周期等信息

>>SUPSiC(国晶微)